Vishay High Power Products

High Performance Schottky Generation 5.0, 2 x 30 A



- 175 °C high performance Schottky diode
- Very low forward voltage drop
- Extremely low reverse leakage
- Optimized V_F vs. I_R trade off for high efficiency
- · Increased ruggedness for reverse avalanche capability
- RBSOA available
- Negligible switching losses
- Submicron trench technology
- Full lead (Pb)-free and RoHS compliant devices
- Designed and qualified for industrial level

APPLICATIONS

- High efficiency SMPS
- Automotive
- High frequency switching
- Output rectification
- Reverse battery protection
- Freewheeling
- Dc-to-dc systems
- Increased power density systems

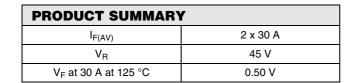
MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL	CHARACTERISTICS	VALUES	UNITS						
V _{RRM}		45	V						
V _F	30 Apk, T _J = 125 °C (typical, per leg)	0.46	v						
TJ	Range	- 55 to 175	°C						

VOLTAGE RATINGS								
PARAMETER	SYMBOL	TEST CONDITIONS	60CPT045	UNITS				
Maximum DC reverse voltage	V _R	T _J = 25 °C	45	V				

ABSOLUTE MAXIMUM RATINGS									
PARAMETER		SYMBOL	TEST CON	TEST CONDITIONS					
Maximum averageper legforward currentper device			50 % duty cycle at T _C = 159 °C	30					
		I _{F(AV)}	50% duty cycle at $1C = 159$ C	60					
Maximum peak one cycle non-repetitive surge current		1	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated	2500	A			
		I _{FSM}	10 ms sine or 6 ms rect. pulse	V_{RRM} applied	450				
Non-repetitive avalanche energy		E _{AS}	$T_J = 25 \text{ °C}, I_{AS} = 8 \text{ A}, L = 4.4 \text{ mH}$		140	mJ			
Repetitive avalanche current		I _{AR}	Limited by frequency of operation and time pulse duration so that $T_J < T_J$ max. I_{AS} at T_J max. as a function of time pulse See fig. 8		I _{AS} at T _J max.	A			

For technical questions, contact: diodes-tech@vishay.com

Downloaded from Arrow.com.



Base 2 common Ç

cathode

2

cathode

Common 3

Anode

Anode d





TO-247AC

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ELECTRICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CO	TYP.	MAX.	UNITS				
		30 A	T ₁ = 25 °C	-	0.58	v			
Forward voltage drep per leg	V _{FM} ⁽¹⁾	60 A	1j=25 C	-	0.67				
Forward voltage drop per leg	V FM (1)	30 A	− T, = 125 °C	-	0.50				
		60 A	$-1_{\rm J} = 125^{\circ}{\rm C}$	-	0.65				
Reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	$V_{\rm B}$ = Rated V _B	-	250	μA			
neverse leakage current per leg		T _J = 125 °C	V _R = naleu V _R	-	20	mA			
Junction capacitance per leg	CT	$V_R = 5 V_{DC}$ (test signal ra	3500	-	pF				
Series inductance per leg	LS	Measured lead to lead 5	7.5	-	nH				
Maximum voltage rate of change	dV/dt	Rated V _R	-	10 000	V/µs				

Note

 $^{(1)}\,$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range	e	T _J , T _{Stg}		- 55 to 175	°C				
Maximum thermal resistance, junction to case per leg Maximum thermal resistance, junction to case per device Typical thermal resistance, case to heatsink		D		0.8					
		R _{thJC}	DC operation	0.4	°C/W				
		R _{thCS}	Mounting surface, smooth and greased	0.25					
Approvimete weight				6	g				
Approximate weight				0.21	oz.				
Manualiante	minimum			6 (5)	kgf · cm				
Mounting torque	maximum			12 (10)	(lbf · in)				
Marking device	device Case style TO-247AC (TO-3P) 60CPT04		T045						

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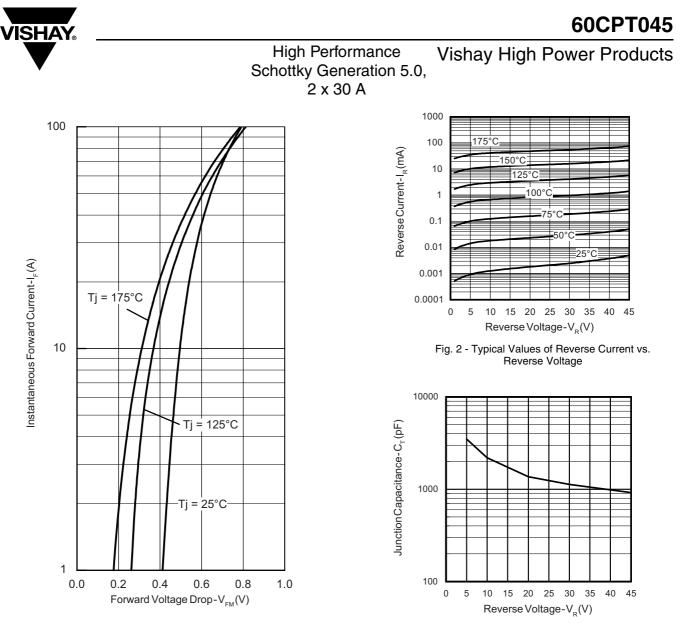
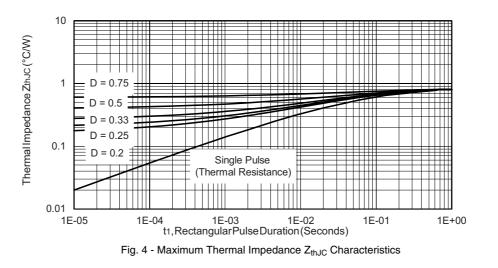
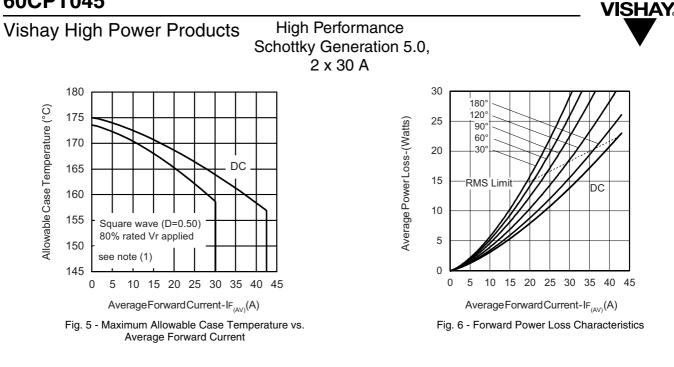


Fig. 1 - Maximum Forward Voltage Drop Characteristics

Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage





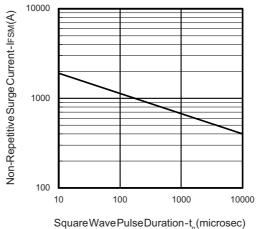
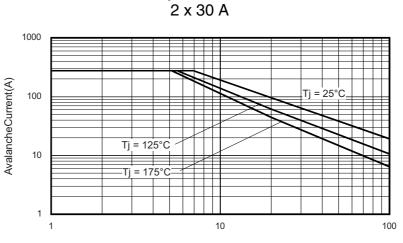


Fig. 7 - Maximum Non-Repetitive Surge Current

Note



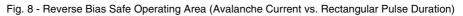
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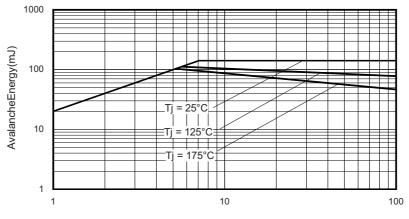


High Performance

Schottky Generation 5.0,

RectangularPulseDuration(µsec)





RectangularPulseDuration(µsec)

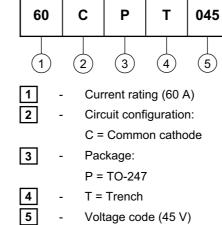
Fig. 9 - Reverse Bias Safe Operating Area (Avalanche Energy vs. Rectangular Pulse Duration)

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ORDERING INFORMATION TABLE

Device code



Tube standard pack quantity: 25 pieces

LINKS TO RELATED DOCUMENTS						
Dimensions http://www.vishay.com/doc?95223						
Part marking information	http://www.vishay.com/doc?95226					

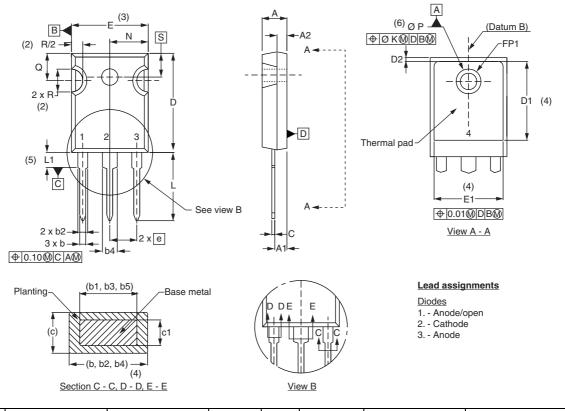
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Outline Dimensions

Vishay Semiconductors

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	MILLIMETERS INCHES		INCHES NOTES		NOTES		MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES		SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209			D2	0.51	1.30	0.020	0.051	
A1	2.21	2.59	0.087	0.102			Е	15.29	15.87	0.602	0.625	3
A2	1.50	2.49	0.059	0.098			E1	13.72	-	0.540	-	
b	0.99	1.40	0.039	0.055			e	5.46	BSC	0.215	BSC	
b1	0.99	1.35	0.039	0.053			FK	2.	54	0.0)10	
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634	
b3	1.65	2.37	0.065	0.094			L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135			N	7.62	BSC	0	.3	
b5	2.59	3.38	0.102	0.133			ΦP	3.56	3.66	0.14	0.144	
С	0.38	0.86	0.015	0.034			ΦP1	-	6.98	-	0.275	
c1	0.38	0.76	0.015	0.030			Q	5.31	5.69	0.209	0.224	
D	19.71	20.70	0.776	0.815	3		R	4.52	5.49	1.78	0.216	
D1	13.08	-	0.515	-	4		S	5.51	BSC	0.217	BSC	

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

(6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

⁽⁷⁾ Outline conforms to JEDEC outline TO-247 with exception of dimension c

Revision: 16-Jun-11

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For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>





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